



B0540W

October 2016

0.5A SURFACE MOUNT SCHOTTKY BARRIER RECTIFIER

Features

- Low Forward Voltage Drop
- **Guard Ring Construction for Transient Protection**
- **High Conductance**
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

- Case: SOD-123
- Case Material: Molded Plastic, "Green" Molding Compound (Note 6). UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020D
- Lead Free Plating (Matte Tin Finish Annealed over Alloy 42 Leadframe) Solderable per MIL-STD-202, Method 208 (3)
- Polarity: Cathode Band
- Weight: 0.01 grams (Approximate)



Top View

Ordering Information (Note 4)

Part Number	Case	Packaging
B0540W-7-F	SOD-123	3,000/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com/packages.html.

Marking Information



SF = Product Type Marking Code YM = Date Code Marking Y = Year (ex: D = 2016)M = Month (ex: 9 = September)

Date Code Kev

Year	2013	2014	2015	2016	2017	2018	2019	2020
Code	Α	В	С	D	E	F	G	Н

Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D



Maximum Ratings (@ $T_A = 25$ °C, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load. For capacitance load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _R	40	٧
RMS Reverse Voltage	$V_{R(RMS)}$	28	V
Average Rectified Output Current (See Figure 4)	lo	0.5	Α
Non-Repetitive Peak Forward Surge Current 8.3ms single half sine-wave superimposed on rated load	I _{FSM}	5.5	А

Thermal Characteristics

Characteristic	Symbol	Тур	Max	Unit
Typical Thermal Resistance Junction to Ambient Air (Note 5) $T_A = 25$ °C	$R_{ hetaJA}$	385		°C/W
Typical Thermal Resistance Junction to Ambient Air (Note 6) $T_A = 25$ °C	$R_{ hetaJA}$	325		°C/W
Operating and Storage Temperature Range	T _J , T _{STG}		+150	°C

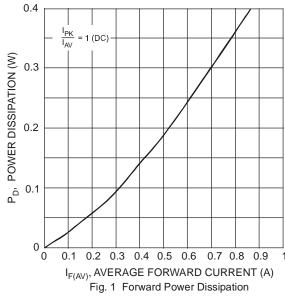
Electrical Characteristics (@T_A = 25°C, unless otherwise specified.)

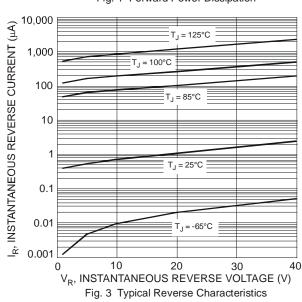
Characteristic	Symbol	Value	Unit	Test Conditions
Minimum Reverse Breakdown Voltage (Note 7)	V _{(BR)R}	40	V	$I_R = 20\mu A$
Maximum Forward Voltage Drop	V _{FM}	0.510 0.620 0.460 0.610	V	I _F = 0.5A, T _J = 25°C I _F = 1.0A, T _J = 25°C I _F = 0.5A, T _J = 100°C I _F = 1.0A, T _J = 100°C
Maximum Lookaga Current (Noto 7)	l	10 20	μA	V _R = 20V, T _J = 25°C V _R = 40V, T _J = 25°C
Maximum Leakage Current (Note 7)	lкм	5.0 13	mA	V _R = 20V, T _J = 100°C V _R = 40V, T _J = 100°C
Total Capacitance	Ст	170	pF	$f = 1MHz, V_R = 0V DC$

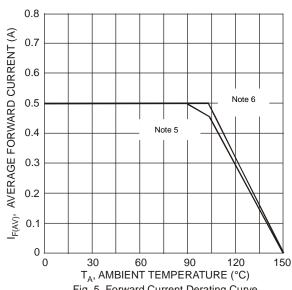
Notes:

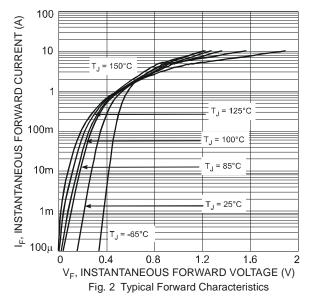
- 5. FR-4 PCB, minimum recommended pad layout per http://www.diodes.com/package-outlines.html.
 6. Polymide PCB, minimum recommended pad layout per http://www.diodes.com/package-outlines.html.
- 7. Short duration pulse test used to minimize self-heating effect.

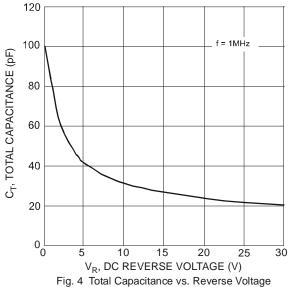








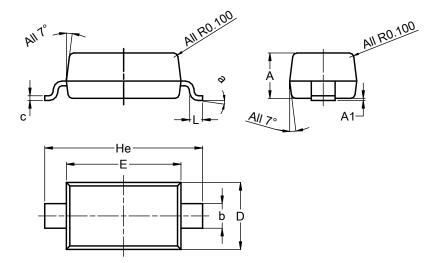






Package Outline Dimensions

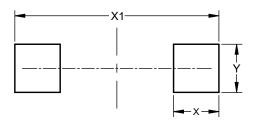
Please see http://www.diodes.com/package-outlines.html for the latest version.



	SOD123					
Dim	Min	Max	Тур			
Α	1.00	1.35	1.05			
A1	0.00	0.10	0.05			
b	0.52	0.62	0.57			
С	0.10	0.15	0.11			
D	1.40	1.70	1.55			
Е	2.55	2.85	2.65			
He	3.55	3.85	3.65			
L	0.25	0.40	0.30			
а	00	8°				
All Dimensions in mm						

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.



Dimensions	Value (in mm)
Х	0.900
X1	4.050
Υ	0.950



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